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## (54) THE: SOLUTION PROCESSED DEVICES

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## SOLUTION PROCESSED DEVICES

This invention relates to solution processed devices and methods for forming such evices

secome of interest for applications in cheap, logic circuits integrated on plastic substrates (C. Drury, et al., APL 73, 108 (1998)) and optoelectronic integrated and inorganic metal electrodes and gate delectric layers high-performance TFTs have been demonstrated. Charge carrier mobilities up to 0.1 cm<sup>2</sup>/Ns and ON-OFF current ratios of 10°-10° have been reached, which is comperable to the performance of amorphous silicon TFTs (H. Stringhaus, et al., Advances in Solid Semiconducting conjugated polymer thin-film transistors (TFTs) have recently devices and pixel transistor switches in high-resolution active-matrix displays (H. Sirringhaus, et al., Science 280, 1741 (1998), A. Dodabalapur, et al. Appl. Phys. Lett. 73, 142 (1998)). In test device configurations with a polymer semiconductor State Physics 39, 101 (1999)). Thin, device-quality films of conjugated polymer semiconductors can be formed by coating a solution of the polymer in an organic solvent onto the substrate. The achnology is therefore ideally suited for cheap, large-area solution processing compatible with flexible, plastic substrates. To make full use of the potential cost and ease of processing advantages it is desirable that all components of the devices, including the semiconducting layers, the dielectric layers as well as the conducting electrodes and interconnects are deposited from solution To fabricate all-polymer TFT devices and circuits the following main problems have to be overcome: Integrity of multilayer structure: During solution deposition of subsequent semiconducting, insulating and/or conducting layers the underlying layers should not be dissolved, or swelled by the solvent used for the deposition of WO 01/47043 PCT/GB00/04934 WO 01/47043

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the subsequent layers. Swelling occurs if solvent is incorporated into the underlying layer which usually results in a degradation of the properties of the

- High-resolution patterning of electrodes: The conducting layers need to be patterned to form well-defined interconnects and TFT channels with channel lengths L.5 10µm.
- To fabricate TFT circuits vertical inferconnect areas (via holes) need to be formed to electrically connect electrodes in different layers of the device.

In WO 991/0898 A2 a nested to identicate an el-poymer TFT is demonstrated beta rise as convention of the suicipa-processed uses of the schole the an instable form pioto to the opcoulton of subsequent layers of the owder. The overcrones the problems of clean-ful or service of suicipa-point payers, between it severely limit bin order of semicroparcial program can be used, to the small and it paveral respects undestable disse of procured poymers. Furthermore, consulting the celebratic payer alteration, consulting the celebratic payer affords, such that shorteges auth as mediantical purchasing senses (IVO 991/9998 and that shorteges auth as mediantic purchasing senses (IVO 991/9998 and that shorteges auth sense).

According to aspects of the present invention there is provided device(s) and method(s) as set out in the accompanying independent claims. Preferred features are set out in the dependent datins.

According to one aspect of the present invention lies is provided a method for claming a transistion, comprising oppositing a first material from evidence using a first shower to form a first layer of the transistic and subsequency whiles the first material remains exhibit in the first solvent, forming a second layer of the transistic by depositing over the first material a second marked from solution in a second solvent in which he for the marked is subsequently includion.

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Preferably the method comprises the further stop of, whilst the second method remains adults in the second solvest in the immigration to the transition by depositing ever the second method is third method in education in a third solvent in which the second material is substantially insolution.

Sultably at least one layer of the translator is formed by int-jet printing (LIP). That layer may be a layer providing an electrode of the translator, for example a gate, source of chin electrode.

Preferably the method compiless forming a fundional layer of the treasters, forming an isother layer over the includional layer may forming a goal of the transient ower the lecition's layer. The includion layer may provide a distance their and/or a suffice prodeforch layer as expension of the same supre.

According to a second sayed of the present invention there is provided a method for confined the solution independent of material to induce uses on the solution. The needed comprises patienting he surface of the underlying abstrate from areas with different surface free every. This solution may have surface sees that are hydrophodic, and others the ser hydrophile. The solution deposition may have be kell principle in the properties are included and outflow are confined and confinement of the link to either the hydrophodic or he hydrophile cubicine areas.

Preferably, the pattern on the substrate defines source and drain electrodes of a translator with a small channel tength of preferably L < 20µm, gate electrodes with a well-defined overtap with the source/drain electrodes, as well as interconnects. According to a third aspect of the present invention there is provided a method for forming via holes to define electrical connections between electrodes and interconnects in different layers. The method comprises dissolution or doping of

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ayers by local deposition of solvents or dopant solutions, preferably by ink jet

According to another aspect of the present invention is provided a method to fabricate an Integrated circuit of transistor devices in which part of the transistor tevices and/or other circuit components are formed by inkjet printing

nethod comprises interconnecting the electronic devices by lnk jet printing of According to another aspect of the prasent Invention is provided a method to abricata an array of electronic devices with at least one exposed electrode. The conductive material in such a way that en electronic circuit with a user-dafined unctionality is obtained. Preferably one of the said first and second solvents is a polar solvent and the other of the first and second solvents is a non-polar solvent. Preferably one of the said first or sacond materials is a semiconductive material, and the other of the first or second materials is a disjectric material. Preferably the second material is a dielactric material, one of the first and third natarials is a semiconductive material and the other of the first or third materials is a conductive material.

soluble in a non-polar solvent. The other of the first and second layers may be a polar polymar layer that is soluble in a polar solvent. The interaction parameter D largar than 10 and most preferably larger than 15. The interaction parameter D One of the first and second layers may be a non-polar polymer layer that is for the non-polar polymer and the polar solvent is suitably larger than 5, preferably for the polar polymer and the non-polar solvent is suitably larger than 5, preferably larger than 10 and most preferably larger than 15.

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Suitably one of the second and third solvents is a polar solvent and the other of

the second and third solvents is a non-polar solvent.

Suitably the second solvent is a moderately polar solvent containing a polar and a non-polar group and one of the first and third solvents is a highly polar solvent containing only polar groups. The second polymer layer may be a moderately polar polymer layer soluble in a moderately potar solvent. Than one of the first or third polymer layers is suitably a non-poler polymer layer, and the other of the first or third polymer layers a poler polymer layer. The Interaction parameter D for the non-polar polymer and the moderately polar solvent may be larger than 5, prefarably largar than 10 and most preferably larger than 15. The interaction parameter D for tha polar polymer and the moderately polar solvent may be larger than 5, preferably larger than 10 and most preferably larger than 15. The moderately polar solvent may, for example, be an elcohol or an acetate. The first layer may be soluble in a non-polar solvent and the second layer may be an isolation layer soluble in a moderately polar solvent containing a hydrophilic and a hydrophobic group. The third layer may be soluble in a polar solvent. Alternatively the third leyer may be soluble in a non-polar solvent

The second layer may be an active layer of the transistor.

Suitably one of the first and second layers is a source and/or drain electrode layer of the transistor and the other of the first and second layers is a semiconductor layer of the transistor. Suitably one of the first and second layers is a semiconductor layer of the transistor and the other of the first and second layers is an insulator layer of the rensistor.

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The said semiconductor layer may comprise a conjugated polymer, preferably a conjugated block copolymer.

The senticonductor layer may comprise a blook copolymer comprising a first block of conjugated monomer units each finded by at least two constent brods, end a second block of monomer units, the block copolymer having an electron affinity greater than 3,000 to 3,504. The semiconductor layer may complete a block capolymer comprising a first block of conjugated monomer units sead. Inited by at least two covalent bords, and a second block of monomer units, the block capolymer having an innitesion potential in the range from 5.84/ to 4.894.

The first block of monorer units may complete one or mine of the group comprising a flacers devander, a provision desirative and the second block of monorer units comprises one or more of the group comprising a throphere deviative, a trianjoinnie deviative and a beatschicklosic deviative.

# The semiconducting polymer may be F8T2 or TFB.

Petraby the senforchocket light compress a fluid-cytaline conjugate obymer. The earbord may then compress the stop of heading the figuric-cytaline obymer into its legal cytaline planes. The memory pretency compress the tast of aligning the fault-cytaline polymer ulminishy. The stop of aligning the cytal-cytal polymer may comprise depositing the fluid-cytaline polymer under is just having an aligned medicular structure. The stop of aligning the structure of the said layer may be performed by mechanically nucking the justitine method preferrably comprises a specific may be mechanically nucking the justition and professing to compress a specific and beautiful to mechanically nucking the justition and professing to the profession of the profession of the profession and profession and profession and the method profession beautiful to since the profession of the profession of the profession and the profession of the profession and the profession and the profession of the profession of the profession and the profession of the profession of the profession and the profession of the profession of the profession of the profession and the profession of the

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The said senticonducts layer is suitably colicially transparent with a band gap layer than 2.344, and preferrably larger than 2.344. The said senticonductor layer stable 1 has an forbefund proprinted larger than 4.544 or 5.444. The senticonductor layer suitably has an electron affinity lagger than 3.444 or 5.444.

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One of the first and second layers may be an insulator layer of the translistor and the other of the first and second layers may be a gate electrode layer of the transletor.

One of the first and that layers may be an intuition layer of the transition; the others of the stand that layers may be a pain section layer of the transition; and the second layer may be an isolation layer of the transition. The intuition; layer may be an influent layer of the transition; The intuition layer may be a milked however, the distuition better layer of the transition; The contract layer may complete a non-post complete, the diffusion butter layer may complete a polythered and entition butter layer may complete a polythered development. The distuition butter layer may complete a polythered development may be a sufficient layer may be a studion modification layer may be one discussed store.

The method may compales the stop of modifying the surface of the first layer prior to depositing the accord layer. The surface modification of the first layer is such as to provide a contead angle of last than 100°, 80° or 80° for deposition of the second marketing onto the first layer less than 100°, 80° or 80° for deposition of the second marketing onto the first layer.

The step of modifying the surface of the first layer suitably comprises treating the surface of the first layer.

The step of modifying the surface of the first layer suitably comprises depositing a surface modifying material on to the surface of the first layer. The surface modifying material may be deposited from solution in a moderalay polar solvent. Suitably the first layer is deposited on to a substrate, and the method comprises heating the substrate prior to deposition of the second or third layer.

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A metrod as cialmed in any preceding claim, wherein at least one of the first

A metrod as Calmed in any preceding daim, wherein at least one of the linst, second and third layers is formed by ink-jet printing.

Suitably at least one of the source, drain or gate electrode of the transistor is

formed by ink-jet printing.

Skitaby the translator has a source, drain or gate electroce formad of a conducting polymer. Sultaby the said electroce is formed of an optically trenspend conducting polymer. Sultaby the conducting polymer contains a polymeric countain open.

Sultably the material of one of the first and second layers is PEDOT/PSS.

Suitably the transistor has an insulator tayer formed of a non-conjugated or partially conjugated polymer. Suitably the insulating polymer contains both hydrophilic and hydrophobic groups and is soluble in a modarately poler solvent.

Suitably the material of one of the first and second layers is PVP.

According to enrother aspect of the present invention there is provided a transistor top-replicing, affects layer that is southain in a first solvent, and a second active top-carpitation, and a second active to adjacent the strat solvent in which the first material is substantially insolube.

The trensistor may professibly comprise a third serive layer adjacent the excord active layer and solution in a through owner. In which the second married is insularizably insolution. Suitably one of the first and second layers comprises a could project the solution in compressible or before of the first and second layers is an innivious propiere solution in rom-point solvent. Suitably one of the second and third layers comprises a polet polymer solution in a openior such leaver of the second red that layers is a polet polymer solution.

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Sullebly one of the first and second layers is a source under drain electrode layer
of the translator and the other of the first and second layers as a sembonduron

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Suitably one of the first and second layers is a semiconductor layer of the transition and the other of the first and second layers is an insulator layer of the transition.

ayer of the transistor.

Suitably the material of which the semiconductor layer is formed is a polyfluorane

The semiconductor layer is conveniently optically transparent with a band gap larger than 2.3eV, preferably larger than 2.5eV. The semiconductor layer suitably has an ionisettor potential larger than 4.6eV or larger than 5.1eV.

The semiconductor layer may comprise a block copolymer comprising a first block copolymer comprising a first block conjugated monoromer units secti layed by at least two covelent bonds, and a sect of block or monoromer units. The block copolymer haring an electron affinity greater than 3,00 V 3,50V.

The semiconductor layer may comprise a block copolymer comprising a first block copolymer comprising a first block copolymer comprising a first block and a second block of monomer units. The block copolymer ferring an lorisation potential in the marge from 56xt to 45xt.

The said list Mode of monemer unit may prompte a or or mine of the group compreting a florence derwide, a. phenytene derwide and an indenditioner derwide, a principle or derwide and an indenditioner adeletes and the second block of monomer units comprises one or more of the opposite or better of the promotive production of the percentage of the principle or the

The polyfluorene derivative is suitably F8T2 or TFB.

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The semiconductor layer suitably has an ionisation potential larger than 4.9eV or

Sulfably one of the first and second layers is an insulator layer of the transistor and the other of the first end second layers is a gate electrode layer of the

Suitably one of the first and shird layers is an insulator layer of the transition, the other of the first and third layers is a gate electrode layer of the furnishot, and the second layer is an isolation layer of the transistor. The isolation layer may be a suit-form modification layer.

Suitably the isolation layer is a diffusion barrier layer. The diffusion barrier layer may comprise a polyfluorene derivative may be F8T2 or TFB.

The first or second layer may be formed by ink-jet printing. The third layer may be formed by Ink-jet printing.

Suitably one of the first, second end third isyers is a source layer of the transistor, snother of the first, second end third leyers is a drain leyer of the transistor, and the other of the first, second end thind leyers is e gate layer of the transistor.

The material of one of the first and second layers may be PEDOTIPSS.

The material of one of the first and second layers may be PVP

The transistor may be optically transparent.

The transistor may be a thin film transistor.

According to a further aspect of the present invention there is provided a logic circuit, display or memory device comprising a transistor as set out above.

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Aboording to a further expect of the green invention there is broucked a logic details or design or memory device convesting an early or the furth array of splitting or an early or many or gallerially or

According to a further espect of the present invention there is provided a display comprising a plurality of display elements, at least one of the display elements being awildned by an opically transparent thin film transistor.

ransistors as set out above.

A transistor as set out above is suitably located behind the display element.

Such a display may comprise an optically acive region switchinds by the translater and the translator is execitively coupled to the optically eache region by man of conductive material located in a via hole formed through at least one loyer of the translator. The present invention will now be described by way of example, with reference to the accompanying drawings, in which:

figure 1 shows different device configurations of solution processed, ell-polymerTFTs;

figure 2 shows transfer characteristics of polymer TFTs according to Fig. 1c with a F8T2 active layer, a PVP gate insulating leyer, end a PEDOTIPSS gate electrode;

figure 3 shows transfer cheracteristics of polymer TFT a according to Fig. 10 with a FBTZ active layer, a PMP gate insulating layer, and a PEDOTIPSS gate electrodes deposited with the sample hald at room lampsreture (e) and approximately SFMC (b). figure 4 strows output (a) and transfer characteristics (b) of a F8T2 elipolymer TFT containing a F8 diffusion barrier and a PVP surface modification siyer as in figure 1(a); PCT/GB08/84934 WO 01/47043

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figure 5 shows transfer cheracteristics of F9T2 all-polymer TFTs as in figure 1(a) with a TFB (a) and polystyrene (b) diffusion barrier and a PVP surface modification layer;

figure 6 shows an optical micrograph of an ell-polymer TFT according to figure 1(a) with an F8T2 active layer and source-drain electrodes printed directly onto a bare glass substrate;

figure 7 shows the facication of TFTs with small channel length end small overtep capacitance through patterning of the substrate surface into hydrophobic end hydrophillic areas;

figure 8 shows optical micrographs of the channel region of transistors with L = 20  $\mu$ m (a) and L = 5  $\mu$ m (b) after LP deposition of PEDOTIPSS source/drain electrodes in the vicinity of 6 hydrophobic polymide bank;

Figure 9 shows optical micrographs taken during the deposition of ink droplets in the vicinity of a polyimide benk.

figures 10 and 11 show output and transfer cheracteristics of transistors formed as in figure 7(c) and heving chemiel lengths  $L=20~\mu m$  and 7  $\mu m$ 

respectively.

Togone 12 shows a softenistic diagram (a) Delitable profilementy and optical micrographs (b) of the process of forming via notes by successive deposition of ornettiand in other papers of the properties only a 1 pin third; PVP gate deletable signer and (c) generation of those should so other and min diameter or the demonstrar of the bridge copies and an an other clamater or the demonstrar of the bridge copies and an other pricesses of the PVP layer;

figure 13 shows the current-voltage characteristics through a via hole with

e bottom PEDOT electrode and a top electrode. figure 14 illustrates different processes to fabricate via-holes;

inguie 1 - minavance unieum is cocases to mannane mentenes (depledenfigure 15 stows applications of visit holes such as logic inverters (depledenf) nebronomer long (h) and modernon long (n) and multiple

figure 10 annua suppredential or tellinose sedit un ago interior proprioder load (a), enhancement-load (b) and resistance-load (c)), and multilevel intercornect schemes (d);

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figure 16 shows the characteristics of enhancement-local inverter circuits as in figure 1(a) flabricated with printed all-polymer TFTs with different ratios of the sizes WR, of the two transistors.

figure 17 shows an alternative bottom-gate device configuration: figure 16 shows a schematic drawing of an edive matrix pixel in which the display or memory element is controlled by a voltage (a) or a current (b);

figure 19 shows possible configurations of the pixel of an active matrix. figure 20 shows potentized optical absorption of en aligned F672 FTTF. figure 21 shows (a) polymer FTTs with a patterned active layer island fathicided by printing of semiconoloxing and delactic layers and (b) the overlap figure 22 shows a matrix of transistor devices connected by a network of NP Interconnects to fabricate user-defined electronic circuits;

region between to conducting interconnects separated by a printed insulating

Preferred interdent method described tensis paren the stefacison of an airorganic, solution-processed the-first formatics, in which more of the layers in
converted or cross-backed the his relaxious from. Each layer of such relevance
email in a form that is exclude the solvent from which is was deposited. As will
be described in more deall bloom, it is enable as sumple way of familiarie. And
have brough describe frainfalling hypes based on the deposited described
Such as device may, for example, control or from or it is followed:
Such as device may, for example, control or from or it is the following.

patterned conducting source-drain and gate electrodes and interconnects.

components:

- a semiconducting layer with a charge carrier mobility exceeding 0.01 cm?V/s and a high ON-OFF current switching ratio exceeding 10°.
- a thin gate insulating layer.
   a difficient herrier leave that product the entire
- a diffusion barrier layer that projects the semiconducting layer and the insulating layer against unintentional doping by impurities and ionic diffusion.

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a surface modification layer that enables high-resolution patterning of the gate electrode by printing techniques.

via-holes for interconnects through delectric layers.
 However, it will be appreciated that the methods described herein are not limited to facilitation of devices having all the features set out above.

The fabrication of a first flustrative device will now be described with reference to figure 1. The device of figure 1 is a thin-film field effect transistor (TFT) configured to have a top-gate shucture.

On to or of a demont 1700 gains authorise it corrected in electrone 2, 3 and infractorise three between the electrones and the control and good for the conducting part of all other positive and the conducting part of all other positive and the conducting polymer oppositive memory observablements (PEDOT (64 weight %), 1 PSS (10 weight %), 1 PSS (10 weight %)). In white, Other electron action membrane, demontal control action on the part of the line; PEDOTPSS is calculated to entire the control action of the part of the proper to the control of the part of the proper is of the procession to electronic the section of the proper of the procession of the pr

The LP of the source-drain electrodes is performed in alt. Aflavarizes the samples are transferred to an inerth empressione glove box system. The substates are then spun-dred in the organic solvent that will list be used for the deposition of the active semiconducting layer, such as mixed xylense in the case of polyhorone acidn semiconducting layer, such as mixed xylense in the case of polyhorone.

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polymen. They are the amendad for 20 minutes at 200°C in fuer intogen almosphere to monox residual societies and color visualle special expension. Then a 200-1000 Å think fills of the active sentencedeate populment 4 is deceased by spiciouslable vibrious sentencedeate by spiciouslable vibrious sentencedeate professed by spiciouslable vibrious according polyment have been used auth as registragular poly-2-terophicipsone (PSH2), and polyment have been used auth as registragular poly-2-terophicipsone (PSH2), and polyment have been used as a terihal spiciouslable of PSH2 in adequation of the parties decircles in siz. A 5-to morth solution of FSH2 in decipools of the pass electricity is a vibrious of the passion of the pa

A takeopeut manufalty got on the top performed to entrace the obtains immunos properties of the amonocologing oppositions of the amonocologing oppositions of the amonocologing oppositions that the properties are deviated temperatures arrasing at a temperature doors be by applicable to the amonocologing opposition to the properties of the applicant designs of the amonocologing opposition to the applicant designs of the amonocologing opposition to the amonocologing opposition to the amonocologing opposition to the amonocologing opposition of the amonocological opposition amonocological opposition amonocological opposition and the amonocological opposition and control of the amonocological opposition and control of the amonocological opposition and control opposition of the amonocological opposition and control opposition of the amonocological opposition and control opposition opposition and control opposition opposition and control opposition opposition opposition and control opposition opposition and control opposition opposition and control opposition opposition and control opposition opposition opposition opposition and control opposition opposition opposition and control opposition op

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electronic trap states in the glassy phase compared to the as-deposited phase, that is partially crystalline.

Futher improvements of the mobility by typically a factor of 3-5 can be obtained if it was be opiner it propered in a monotomic side about involved alignment of the polymer obtains generally and the polymer obtained by control the gase suicidates with a suitable alignment layer, such as a monotomically nutbed polymicial jarred for figure of this monotomical asset as the polymer ordering agency of polymide layer of first to (b). In the monotomical same than the polymer ordering agency flags with its results in a further entracoment of direg center mobility and devices in which the ITT entered is permit to the adjurcted detection of the claims. Such a process is externative in more detail in our co-pending UK patient application numbe get 544581.

What expending of the semiconduct lives, to get also husbing upine? It is with expending to the semiconduct lives, to get an experiment of paper and obyhydrocating to action of polyhydrocatylynes (PVP)) from a poler achievent in which the underlying manniconducing polymer is not achieved. A preferred action of solvents are actions on an entranci, 2-propertied to Yannon, in which corporar polymers acts has a right pare accorptionally low solubility and do not seel. The trickcess of the gate and any polymer is not action of the properties of the gate and any polymer acts are propriets and any 1-3 am solution and 2-3 am solution 2-3 am solution and 2-3 am solution 2-3 am solution and 2-3 am solution 2-3 am s

The gate electrode 6 is then deposited over the gate insulating layer. The gate beloctrode layer may be deposited directly over the gate insulating layer (see figure 1(c)) or there may be one or more intermediate layers (see figure 1(s) and (b)), for

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example for surface modification, diffusion barrier or process reasons such as solvent compatibility.

To form the simpler device of figure 1(c) a PEDOT/PSS gate 6 may be printed directly on top of the PVP insulating layer 5. The substrate is transferred to the LIP station in air again where a PEDOT/PSS gate electrode pattern is printed from a water solution. The underlying PVP gate insulating layer has a low solubility in water such that the integrity of the gate dielectric is preserved during the printing of the PEDOT/PSS gate electrode. Although PVP contains a large density of polar hydroxyl groups, its solubility in water is low because of the very non-polar polystyrene-like backbone. Similarly PMMA is Insoluble in water. Figure 2 shows he transfer characteristics of an IJP TFT with a F8T2 semiconducting layer, a PVP gate insulating layer, and IJP PEDOT/PSS source-drain and gate electrodes. The device characteristics are measured under nitrogen atmosphere. Consecutive measurements are shown with Increasing (upward triangles) and decreasing (downward triangles) gate voltage, respectively. The characteristics belong to devices made from a freshly prepared batch (a) and a one-year old batch (b) of PEDOT/PSS (Baytron P). Transistor action can clearly be seen, however, the devices exhibit an unusual normally-on behaviour with positive threshold voltages Vo>10V, whereas reference devices fabricated with evaporated gold source-drain and gate electrodes were found to exhibit normally off behaviour (Vo < 0). In devices formed from the "old" batch of PEDOT (figure 2(b)) large hysteresis effects were observed which are attributed to high concentration of mobile lonic impurities (see below). If the sweep is started in deep depletion (Vg=+40V), the transistor turns on at Vo = +20V (upward triangles). However, on the reverse scan (downward triangles) the transistor only turns off at Vo > +35V. The normally-on behaviour and the hysteresis effects are likely to be caused by the diffusion of lonic species in one of the layers of the device. The unusually large positive values of V<sub>6</sub> suggest that the lon is negative. A positive species

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would be exceeded to components are of the models decape by the accumulation age and seld to a shift of V<sub>1</sub> in more negative velocit. To clearly the origin of his love species obstants were individual in velocit his to the species to be proceeded was represented by an expensation gold electronic wells to soften leyers which the DEOT is convoident, electronic gold excellent which the other leyers and the PEOT sourcedent, electronic gold excellent as described above. It was bound that this configuration where devices are membring-off and exhibit table transfer devices are related to the subject of appointing of the exloquise. The transfer is the adoption deposition of the conducting polymer boyance velocities and the possible full femal of models build impurities from the PEOT readulation into the underlying layers of the device. It was 'courd to be possible its control the value of the breakedost voltage and to celectar the amount of hybraness by copealing the gaps electricis ento a header absorber. This reclasses the objing time of the disposit on the substitute. Fig. 5(0) shows the transfer characteristics of a TFT device for velocit the autostrate was resided to the impactance of STO -Classif deposition of the gate electrode. If can be seen that the hybranesis effect, it much smaller has not gape deposition at hom immoneture (Fig. Sc), and that I's has a relatively mind positive value of (V) By conducing the constraint in the relative to the section of his and mange of V, a +500.

Devices with gate electrodes deposited directly onto the PVP layer as in figure 1(c) ere of the depletion-type. This normally-on behaviour is useful for depletion-type logic cricuits such as the stripte depletion-bad logic inventor (figure 14(a)).

To discholate experimental-type, normally-cut Titze to doping of the preparation of sufficient benefit experient to gate on the provised by hospoposition of a diffusion benefit layer, in the device of figure it (a) part (b) and (b) and its layer of a low-cope reporter to expension of the pure of the plant benefit layer. The description of the conducting polymer gate electrode, This layer is price to the deposition of the conducting polymer gate electrode.

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abblewed to ask at diseaso burst include; the california or lovin geoder trough the moderately goine PVP hardinar. PVP conduirs a high density repair lystomy groups which land to enhance the conductivity and californity or loves through the first. Several analyses proper power has been used and as the Sobial Schoolikoores (Fig.) polystomes (Fig.) poly(95 School)chloores (Fight and several poly(95) poly(95 School)chloores adults in some poly(95) pol

printing of PEDOT/PSS is possible on the surface of PVP. Alternative surface exposure of the surface of the non-polar diffusion barrier to a mild O<sub>2</sub> plasma rendering the surface hydrophilic. A suitable plasma treatment that does not degrade the TFT device performance is exposure to a 13.5 MHz O<sub>2</sub> plasma with a Direct printing of PEDOT/PSS from a polar solution in water on top of the nonpolar diffusion barrier layer or on top of a moderately polar polymer such as PMMA has been found to be problematic because of poor wetting end large contact angles. To address this, a surface modification layer 8 is deposited on top of the non-polar polymer. This layer provides a hydrophillic rather then hydrophobic surface on to which the PEDOT/PSS may more readily be formed. This permits enables high-resolution printing of the gate electrode pattern. To form the surface modification layer a thin layer of PVP can be deposited from isopropanol solution, in which the underlying diffusion barrier layer is insoluble. The trickness of the PVP layer is preferably less than 50 nm. High-resolution modification layers may be used. These include thin layers of soap-like surfactants or polymers containing a hydrophilic and a hydrophobic functional group. These molecules would tend to phase-separate with the hydrophobic and hydrophilic groups being attracted towards the Interface with the underlying nonpolar polymer and the free surface, respectively. Another possibility is the brief power of 50 W for 12 s.

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A surface modification layer on top of the non-polar diffusion barrier may not be required if the gate electrode is printed from a solvent that is less polar than water such as formulation containing alcohois (esopropand, metherol etc.). The Integrity of the layer sequence releas on the alternating deposition of polymer materials from polar and ron-polar solvents. It is destalbable that the solventity of a first layer in the solvent used of othe opposition of a second layer is less than 0.1% weight pre-volume, profestally less than 0.01% weight pre-volume,

The chellon for schools competible may be qualted using the indebtand outside guarantees by which the diggers of positive are no currentle (DW. was received. Proporties of polymers, Elsevier, Amsterdam (1990)). The establish peakwax, of such polymer (plany) is executed by these dismanding parametes is, is, is, charactering the degree of dispositive interaction, polymer, and bytogoph inchrigh (instancing believes) polymers (polymer produced in the quiet false, Visuae for these perameters and be accidated if the molecular shouters is known by adving contributions from the different funditional groups of the polymer. They are balanced for most common polymers. Other is, and is, and is, we dis-

The free energy of indired is splen by  $\Delta d_0 = \Delta d_0 = 1/2 \delta_0$ , where  $\Delta \delta d_0 = 0$  is the interpry of indired is splen by  $\Delta d_0 = \Delta d_0 = 1/2 \delta_0$ , in where  $\delta d_0 = 0$  do during an above  $\delta d_0 = 0$  for lower (8) in the mixture). From this is exposed that a polymer (9) is the more exclude in a solvent (8) the smaller  $\Delta d_0$ , is, the more exclude in a solvent (8) the smaller  $\Delta d_0$ , is, the more exclude in a solvent (9) the smaller of the law, i.e., the mixtured or the number of the smaller in the sale of the smaller in the subsequence of the smaller in the solvent in the solvent in the shorter of the smaller in the solvent in the single than the solvent in the solvent in the solvent in the solvent and no evening occurs.

In order to obtain sufficiently abrupt interfaces in a solution-processed TFT device it is therefore destrable that the respective D values for each of the polymer layers and the solvent of the next layer should be larger than approximately 10. This is

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particularly important for the semiconducting polymer layer and the solvent of the gate delectric. In the case of F872 and isopropernol (buty) acetale) we estimate D to be approximately 16 (12).

for some device onfoguistics are then multiples queue, betti justy an administing equence of polymers that contain marky polar groups and ear soluble is a highly polar solvent such as valler, and polymers that contain only a five or do no contain any polar groups and are soluble to incorpline activity, such as yellow, in this case the interaction parameter to large possible or non-polar solution, such as yellow, in this case the interaction parameter to large possible or host would be a translater device containing a behilp yellow according to the out of the not size. An example would be a translater device containing a behilp yellow great solution as the decicion of PEDOTTORS, a non-polar semiconducing layer and as 1871, a highly-polar great defection byer such as a polytreplactorial deposities from weets solution, a non-polar administration of the high sequence, and PEDOTTORS gas been decorrect.

However, it is often convenient to these a con-point entitional-circing layer and a place gas electrode layer executed by a single delectric layer. These layer executed is also possible by using a moderative point polymer layer decident an encoderate groups, explicated to the layer decident and more point on promoted protection to the layer decident and more point and more bre establish parameters a moderately point exhaunt fine point such and point and more point and point and point and more point point

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is attracted to the functional group of the polymer. This attraction may be a phytogen brough interaction. The intenditually of the polymer may be used to principal to intenditually or the proper above and decrease its authority to a moderately point extend and decrease its authority to a moderately goint polymer as a PUP gate delection layer satisfactorized between a non-popula eminocotatorized layer and a PEDOIPPSS gate electron layer (TS), 4.5, he sumple of a moderately polar solvant is an advisorotated such as PA(se, EFTZ, 5, 4.0).

Expute a shown to include (a) and results (a) alternational ord as alphopmer PETZ LD FTT with a PAP gain branders laye, a FB direction brainer layer and a PAP surface modification layer, as illustrated in (gum (s)) (L = 50 µm). The evidence excited training many and produced and surface (A). The threshold voltage single theorem upward (present circumples) and downward professionant integration placeges exage is SY. The devoked and downward with Au source-drain for the alpha excitodes. The allow discretely and evidence or conflorer with Au source-drain for the securices. The allow discretely alpha excitodes. The allow discretely allow and GO 2000-COI Trive and the OVI-OFF current ratio measured between V<sub>F</sub>-0 and GOV is not the order of 10<sup>3</sup>-10<sup>3</sup>. Devices have been included with a robot among of troops of distinct barrier payer, also as FR TTP (type 4(p) doors trender characteristics). PS (typur 10) shows transfer characteristics), and FST3. In each sea clean normaly-off behaviour and manife hybrides a letter and transfer doughs with were characteristics, which were of the same optic of magnitude as those of reference devices with gold source-drain electrone. This appointed the interpretion that impulses carrier and enter the establishment of the gold interface of their This has been found unless the establishment of the gold interface or the This has been found to result in respondable TFT threshold voltages and good

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Normally off devices containing a diffusion barrier are preferred compared to the depletion-type device described above, since it is expected that the former orabit bette for your temelously and better ittelines due to suppression of lone diffusion.

For the seminocultural guest my solution, procession conjugated polymeric or objourned confidence that which a selection in force freez mobilities accounting 10<sup>th</sup> cartifys, preferably exceeding 10<sup>th</sup> cartifys, my be used. Subble membries are relevant for example in He. Eduz, J. Mater. Chem. 7, 589 (1987), or Z. Boo, Advanced Marketis 12, 227 (2000).

described above this reductive post-processing step cannot be performed since it One of the important requirements to fabricate printed TFTs with good stability and high ON-OFF current ratio is good stability of the samiconducting material against unintentional doping by atmospheric oxygan and water during the processing and printing staps. Printed TFTs have been fabricated with a range of semiconducting polymers as the active samiconducting layer, such as F8T2 (see above), or regioregular P3HT deposited from mixed xylene solution. In the case of P3HT TFTs prepared in test device configurations under inart atmosphere the field-effect mobility of 0.05-0.1 cm<sup>2</sup>/Vs is somewhat higher than in the casa of F8T2. However, regionegular P3HT is unstable against doping by oxygen and/or water, resulting in an increase of the film conductivity during the printing steps in air and poor ON-OFF current ratio. This is related to the relativally tow ionisation potential of P3HT, Is = 4.9 eV. High ON-OFF current ratios of >10" have been demonstrated for P3HT, but this requires a reductive dedoping step after the deposition, such as exposure to hydrazine vapour (H. Sirringhaus, et al., Advances in Solid State Physics 39, 101 (1999)). However, on the IJP TFTs vould also result in dedoping of the PEDOT electrodes and reduce their conductivity significantly. Therefore, to achieve high current switching ratios it is

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mmportant that a polymer semiconductor is used with good stability egainst inintentional doping by oxygen or water.

A preferred task or distratible to acception good encountered stability and high motivity. But a ABI (righted biothecopolymens containing a regular ordered sequence of A and B bootis Suitable A blocks are structurally veel defended judden speep morbies who high stant good, him have high broissance possessis agent than SEAV sea as Promophymer and good environmental sidelity. Earnysia of stabilish A boots are broissance desirations (a) SEAT (TOD), therefore development of stabilishes (S. Seayest, Mamorronicales St. 2010 (2000)), belong morbid interesting morbid minusporing morbidges has been interesting assist as and a suitable of infrages, and as a bromophymer have located to potentiale less than suitable of infrages, and as a bromophymer have located to potential less than potential of the structure. The bromatering potential of the aboots copolymer is protected by the range of 4.94 × 5.4 SeX. Demanges of seath copolymer are PTZ principles or personal sets. SeX. SeX. Demanges of seath copolymer is

Other suitable hole transporting polymers are homopolymers of polythophers devirables with indication polential larger than 5 eV, such as polythophers with selexy or sucronated side chains (R.D. McCullough, Advanced Materials 10, 85 (1999)).

inteact of hote transporting semiconducting polymers soldule electron transporting materials may be used as well. These orque is high electron affinity interpreting materials may be used as well. These or high electron definition interpreting and a 4-4, preferrably large tests in 5.8 eV, to prevent residuit annopotation interpreting and a 4-4, professional and a source transporting annual moistoide a materials may include electron processible electron-transporting annual moistoide electron-transporting annual moistoide annual confidence (Hz. Cate et al., Nature 404, 178 (2000)), or polytriopiame definitions with selectron.

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deficient binancia et de chaix. Apply bolic oppoymes with estimating-verification deficient, indice-type A tolic wift is help licination pointed langer than 5.80 via an electron-statisphing is block that 'crossess the electron infinity of the oppoyment or water infinity of the supplier of the properties of the statistic philade than 3.80 via easilable. Extraples of A. blocks are flooring electronically information of 3.7177(7) information of the statistic philaderical philaderical

overtip between source/drain and gate of have to be es small as possible, text is spicially a few minrors. The most call amention is Libocouse the operation speed of a treatistic direct it is approximately approximate to Lift is a periodually important for enriconducting layers with relatively low notelity.

For fast operation of logic circuits the channel length L of the transistors and the

Such diplementation patenting cannot be achieved with presection in high patenting between the interest of the patenting which is finished to feature size of (102) pure even with table effected LIP between the patenting of the finished patenting and determine practicing of features in resoluted them is between the stall parts of the stall parts enterting the confine taking end carcing between these used of the stallness transactions to confine taking displaced only a stallness of a substalle. This technique can be used to scholars with a markler columns impate that no early event of the stallness of the convention and the convention and the scholars is the parts of the stallness of the convention and the scholars is the parts of the stallness of the convention and the scholars is the parts of the scholars in the scholar in the scholar

This confinement technique can be used to permit fine-resolution deposition of a deposited material on to a substrate. The surface of the substrate is first treated in order to render selected parts of it relatively attractive and relatively repellent for

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ne material to be deposited, For example, the substrate could be pre-patterned no as to be partially hydrophotic in some areas and pretailly hydrophilic in other to the pre-patterning data performed at high reaction and/or precise registration the absenqued deposition can be accurately defined. One enhabitment of properbarrage it leastful to flogue. To Egue 7 Bazzares the charmed or of a device of the system in figure 1(c) but with an expectacing the charmel length. L. Lies parts are a numbered as for figure 1(c). Figure 7(c) Listentines employ to histories a prepairment signer 7(c) Eugen 7(c) Listentines employ to histories a prepairment signer 7(c) illustrates printing and only confirmment on a prepairment adultities.

the glass substrate ereas hit the boundary of a hydrophobic polyimide region 10 sreas only and high-resolution patterns with small gaps and transistor channel Prior to the deposition of the source-drain electrodes 2, 3 a thin polyimide layer 10 is formed over the glass sheet 1. This polyimide layer is finely petterned to emove it in the places in which the source-drain electrodes are to be formed. he removal step may be done by a photolithographic process to allow fine eature definition end/or accurate registration. In one example of such a process the polyimide may be covered with a layer of photoresist 11. The photoresist can se patterned photoithographically to remove it in the places where the polyimide is to be removed. Next the polyfinide is removed by a process to which the photoresist is resistant. Then the photoresist can be removed to leave the accurately patterned polyimide. Polyimide is selected because it is relatively hydrophobic, whereas the glass substrate is relatively hydrophilic, in the next step PEDOT meterial to form the source-drain electrodes is deposited by Inkriet printing onto the hydrophilic substrate ereas 12. When ink droplets spreeding on he ink is repelled and prevented from flowing into the hydrophobic surface areas. Through this confinement effect the ink is deposited in the hydrophilic surface angths of less than 10 µm can be defined (figure 7(b)).

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One example of process by which he objinded my be removed, or which may be employed to enhance it is easier a effects after removal of polymina to example of the proposesses it is expected in figure 7(a). The polymina typer (1 and the proposessis it is exposed to an oxygen plasma. The oxygen plasma adress the thin (500 Å) polymina super states than the thick (1.5 ml) polomestal signs: The exposed bear polymina super states and the thick (1.5 ml) polomestal signs: The exposed bear polymina subject to see of the sourcedom's electrones in radio very hydropkilo by exposure to an O<sub>2</sub> plasma prior to removed of the polymina is producedst. Note that during the more and of plasma prior to removed of the producedst. Note the producedst and remains hydropholics.

If requerty the polytimide surface can be made even more hydrophobic by an additional exposure to CF, planna, DF, plenna in Ambrahama and additional exposure to the or CF, planna, DF, plenna in Ambrahama and a particular and a

The contact angle of PEDOT/PSS in water on O<sub>2</sub> plesma-treated 7058 glass is  $q_{\rm gas} \approx 20$  compared to a contact angle of  $\theta_{\rm pl} \approx 70^{-40}$  on the polyfinide surface. The contact angle of PEDOT/PSS in water on flucthread polyfinide is '20'.

When PEDOTIPSS is deposited from a water solution onto the pre-patterned polythride layer as described, the PEDOTIPSS link is confined to the source-drain electrode areas even if the channel length I. Is only a few microns (figure 7(b)).

To fishable the confinement of the copies has within energy of its cloples is in larger are made as possible. The import he short of the droplest, the larger the idence energy, and the larger the probability that the apreading droplest will "groot the hydrocytic confinement studies and spill over into indipicuming hydrocytic restore.

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Perfectably cognition of the inflorable is a onto the hypothile substitute between yellogened of the inflorable superation of the order of the circuit and the polycitide boundary.

On one hand of needs to be sufficiently small that the boundary is nuclead by the appearability is come the EEOOT file modes at the web polycitide boundary. On the other hand, of meet to be sufficiently large that the replydrice boundary does not "yell over it not be the polymer leader of the polycitide boundary is set of EEOOT deposition on the the polycitide boundary the ITT channels and may give rate to the polycitide boundary of the ITT channels and may give rate to the polycitide boundary of the ITT channels and may give rate to the polycitide boundary of the ITT channels and may give rate to that deposite onto the alterial pint of 12.5 m between the supposition of the OEOD continum visited of these of a 30-dig min was found statistic. The office of a 30-dig min was found statistic. The deposition properties on the surface as wall as on the deposition pinch, that is the sizeral definance of the surface as wall as on the deposition pinch, that is the sizeral definance of the surface as wall as on the deposition, with which coincides are deposited, and the deposition, with which coincides are deposited, and the deposition, of the other and the proposition of the soldion.

The hydopolocic confinement layer to define the claramed langin of the transistor may also provide a second fundicionally. It may be used as an adjuring template for the subsequent deposition of the semiconducing polymer in the demonst of the transister. The polymice layer (only on emocratically tubbed or polonishingment or the used as an informent layer (light) for provide and on the house as an informent that experience (ago (40)). To provide monoclocular lagitiment of a tight-depositible semiconducing polymers 4.

The gas electronic entry is estimated orchited by estimated layer (formed on you of the gast trainlating layer 5 that provides attractive and replacing sufficient areas for the southon from exist the gate electrodic is deposited. The pathomical wayer of may be agained with respect to the source-droming pathon to institution be younged in the beginning and gate electrodical (Figura 10).

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Materials other than polytimide may be used for the pre-patienned layer. Other accurate pre-patiteming techniques than photolithography may be used.

Figure 8 demonstrates the shiply of a structure of melanop lycincipicios and prigraphic layers to confres fleid in "the deposition by taked primits". Figure 8 above optical indexpaging of substrates including this rapped of polymetric Orbits have been trained as described above to be relatively projectible and imperimental or the based on the confined primits are been trained as the confined above to be entirely projectible and imperiment has been deposited by the piper EDOT melant for the source and dam describes to be an entirely projectible. EDOT melant for the source and and melanoles to be sent from the adversarial or shared or confraint from the sent from the adversarial trained and confined by the strips of a sent from the adversarial melant instantial base has continued by the strips of wend own to an entirely the strips of the event down to an eithy belocutes of 1 = 5m.

Figure 9 d'owns phospapha for ha in ½ disposition process in the violinity of a polyhelike stift (i). The images were taken with violinity of a polyhelike stift (ii). The images were taken with a terchoscopic commer mountail understands to be sent as stift in sea. The if we designed it the polyhelike patient in designed to be sent as stift in sea. The if we designed it is an ejection from the most of the three of the polyhelike stift in the polyhelike stift

Figures 10 and 11 about outbut and treated characteristics of transistors formed as in figure 100; and haring charred lengths L of 20 µm and 7 µm responsibility defined by means of the differential weiting process electrical above. In pair cases the character with Vit is 21 mm. Figure 10(a) having coupled characteristics of the 20 µm device. Figure 10(b) stores output characteristics of the 17 no reviou. Figure 11(a) stores transite characteristics of the 20, µm device. Figure 11(a) and PCT/GB08/04934 VO 01/47043

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above transfer characteristics of the 7 µm device. The 7 µm device shows phasenselsts; such characteristics with network current as transferon-characteristics and the couper conclusions in the statistics regime, in metalty and ON-OFF current mit of short characteristics of the first of the large diament devices in similar to that of the large characteristics of the couper of t Int confinement, is a result of the difference in weiling properties on the projectories and high projectories in high display the register ancorated in The result on a share that the projectories in the factories as statement one has beaut, using as the full controller (SAM). In the sease parabellar with a particular displayment months have a the full controller (SAM), the sease projectories with a particular displayment on the projectories of the controller (SAM), the full projectories with a particular displayment of projectories and the support projectories and the season of the particular displayment of the controller season and the season of the particular displayment and Lagrant 2000, or intercoorated printing printing of familia and L. Papies where New 1984, p. 31).

Pre-patients of the substants in ready compatible with the process flow concrete above as the systems in ready compatible with the process flow types of the TET. Therefore, a broad maye of patients good to think operation as the size of patients of the TET. Therefore, a broad maye of patients good to printing background as the size of the TET. Therefore, a broad maye of patients good to printing background in the persent in the presents in the present without making degradation of the service population.

Smillar techniques can be applied to pre-pattern the surface of the gate invaliding leyer or the surface of the gate invaliding leyer or the surface and additional leyer point in the deposition of the gate electrode for exterior errail overlation continued by a partitional leyer (4. One possible embodiment of such pre-may be conflicted by a partitional leyer (4. One possible embodiment of such pre-

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atterning is microcontact printing or UV photopatterning of a self-assembled nonclayer (SAM) containing chlorosilane or methoxy silane groups, such as actadecytrichicrosilane. These molecules form stable monolayers on the surface of a SiO<sub>2</sub> or glass substrate where they chemically bond to the hydroxyl groups on he polar surface, and render the surface hydrophobic. We found that it is possible a form similar mondayers on the surface of the gate dielectric polymer such as PVP or PMMA. This is believed to be due to bonding of the molecules to the hydroxyl groups on the PVP surface. A surface free energy pattern consisting of a fine hydrophilic line with a well-defined small overlap with the source-drain electrodes surrounded by SAM-costed, hydrophobic regions can easily be defined by soft lithographic stamping. The stamping may be performed under an optical microscope or a mask aligner in order to align the stamp pattern with respect to the underlying source-drain electrodes. When a conducting, water-based polymer link is deposited on top the deposition is confined to the fine, hydrophilic ine defined by the self-assembled monolayer. In this way a smaller linewidth can be achieved than the normal linewidth on en urpatterned gate dielectric leyer. This results in a reduction of source/drain-to-gete overlap capacitance. With the help of pre-patienned substrates it is possible to fabricate high-speed logic circuits based on the TFT and via-hole fabrication process described herein.

One of the crucial reputements for the fatherdation of transition clothal cover large wasses if the registration and algoriment of the deposition with respect to the patient on the substants. Actioning algorithms registration in particularly difficult on finish authorities that existing allocative presents. If between subsequent patienting super to be substantially application to process and no longer covers with the underlying patient. The high-resolution that process developed here is subside to actions accurate migrations over timp season work on a patient contribution to the deposition of the high patient of the patient on the substant for the patient can be substant for the patient on the substant for light set.

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ocal alignment process can be automated using pattern recognition techniques using images such as that of figure 9 combined with a feedback mechanism to correct the position of the inkiet head.

in code to brom, a multi-ansieth emigrated cord under devices for the type central devices it is detailed to be able to make via hole infectionated strongly through the thickness of the device. This can allow scut clouds to be formed sepsceledy contenting to the device. This can allow scut clouds to be formed sepsceledy contenting to the device. This can allow the transitional polynomial value in the set of the set of the set of the TTF is described above the best contenting the set of the set of the set of the TTF is described above the best contenting the set of the set of the set of the TTF is described above the set of the set of the set of the set of the STF is described above the set of the set of the set of the set of the STF is described above the set of the STF is described to the set of the STF is described above the set of the STF is described to the STF is described above the set of the STF is described to the STF is described above the STF is described to the STF is described above the STF is described to the STF is described above the STF is described above the strong the STF is described above the STF is described above the strong the STF is described above the STF is described above the strong the STF is described above the STF is describ In order is make a solven-desmed via hole (figura 12(b)), a currity of a suitable abover 25 is deposited locally to top of the agent toward wind the via the lab to be comed. The accivact is extended so that it is organize of diseasions the ordering lab solven the selected so that it is organize of diseasions throughly represented the lab to be to be comed. The account after throughly rely propagation of the lab solven for the via the lab solven that the method of depositing it may be a selected for trifficial and obsolver a text in method of depositing it may be a selected for trifficial and obsolvers. However, three professorings it may be a selected for trifficial and obsolvers and the selected for trifficial and obsolvers are the restrict of descriptions.

- t, that the solvent and the process co-collions are each that the advent evaporates or is otherwise readily removed so that if does not interiew with subsequent processing and does not cause excessive or inaccurate dissolution of the device; and
- that the solvent is deposited by a selective process such as IJP, whereby accurately controlled volumes of the solvent may be applied accurately to the desired location on the subsitate; and
- that the diameter of the via hole is affected by the surface tension of the solvent droplet and the ability of the solvent to wet the substrate; and

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 that the solvent does not dissolve the underlying layer to which an electrical connection is to be made;

sectrode tayer 26 and a glass substrate 25. In this example it is desired to form a ria hole through the insulating PVP layer. Methanol is selected as the solvent because of its ability to readily dissolve PVP; because it can easily evaporate so head is moved to the location on the substrate et which the vie hole is desired to be formed. Then the necessary number of sultably-sized droplets of methanol are successive drops is selected for compatibility with the rate at which the methanol dissolves the layers of the device. It is preferred that each drop has fully or hole reaches the bottom non-polar semiconducting layer the etching stops such othenol, butanol or actone may also be used. To echieve high throughput it is destrable to complete the vie-hole by deposition of a single solvent droplet. For e 300 nm thick film and a droplet with a volume of 30 pi and diameter of 50 µm this requires the solubility of the layer in the solvent to be higher than 1-2 % weight per rotume. A higher boiling point is also desirable if via-hole formation with a single droplet is required. In the case of PVP 1,2-dimenthyl-2-Imidazolidinone (DMI) with Figure 12(a) illustrates the deposition of a droplet 29 of methanol solvent containing 20 ng per droplet) on a partially formed transistor device of the general ype illustrated in figure 1(c). The partial device of figure 12(a) includes a 1.3 µm hick PVP insulating layer 28, an F8T2 semiconducting layer 27, a PEDOT as not to hinder subsequent processing; and because it has satisfactory wetting properties for PVP. In order to form the via hole in this example on IJP printing dropped from the UP head until the via is complete. The period between almost fully evaporated before the next drop is deposited. Note that when the viahat underlying layers are not removed. Other solvents such as isopropanol, a bolling point of 225 °C can be used. Figure 12(b) illustrates the effect of the dropping of several droplets of methanol in sequence onto the via hole location. The right panels show micrographs of the

sevice after 1, 3 and 10 droplets have been dropped. The left panels show Dektak surface profile measurements of the same devices across the via hole as t is formed. (The location of the via hole is indicated generally at position "V" in each panel). When several droplets are deposited in sequence onto the same ocation a crater opens up in the PVP film. The depth of the crater increases as successive droplets act, and after approximately 6 droplets the surface of the underlying F8T2 layer is uncovered. The dissolved PVP material is deposited in a wall W at the sides of the via-hole. The diameter of the via-hole is on the order 50 um limited by the size of the droplet. This size is suitable for many applications such as logic circuits, and large area displays.

required, such as in high-resolution displays, even smaller droplet sizes can be used, or the substrate surface can be pre-patterned by a sultable technique to confine the droplet on the surface as described above. Other solvents may also The via-hole diemeter is determined by the size of the inklet solvent droplets. The dismeter of the hole was observed to be directly proportional to the diameter of the droplets (see Fig. 12c). The outer diameter of the side wall is determined by the size and spreading of the first droplet, and is independent of the thickness of the polymer layer that is dissolved. The inner diameter of the side wall decreases with increasing polymer thickness. For applications where even smaller holes are

han illustrated by figure 12(b), the x and y axes of the surface profile plots of where it remains after the solvent has been evaporated (indicated at W in figure 12(b)). It should be noted that the displaced material is of a smoother formation t will be seen from the surface profile measurements that the formation of the via hole causes material to be dissolved and displaced to the edges of the via hole, igure 12(b) being to dissimilar scales (x in units of µm, y in units of A).

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The mechanism for via-hole formation, i.e. the movement of material to the side

valls, is believed to be similar to that of the well-known coffee-stain effect, which occurs if the contact line of a drying droplet containing a solute is plinned. Pinning can occur for example due to surface roughness or chemical heterogenetly. Note hat deposition of a good solvent always generates surface roughness during dissolution. When the solvent evaporates, capillary flow occurs in order to replace contact line because of the larger surface-to-bulk ratio near the contact line. The capillary flow velocity is large compared to the typical diffusion velocity, such that solute is carried to the edges of the droplet, and solute deposition occurs only near the rim, but not in the centre of the drying droplet (R.D. Deegan et al., Nature 389, 827 (1997)). Diffusion of solute would tend to favour homogeneous edeposition of the polymer over the whole area upon drying of the solvent, rather than formation of a side wall. Theory predicts that the capillary flow velocity v(r) (r. distance from centre; R; droplet radius) is proportional to (R-r)\*, where  $\lambda = (\pi -$ 29.)/(2n-28c). Therefore, v Increases with Increasing 2, that is decreasing contact angle 8<sub>c.</sub> Therefore, mass deposition at the edges occurs the faster the smaller he solvent evaporating near the contact line. More solvent is evaporating near the the contact engle.

solvent is sufficiently fast such that polymer solute diffusion can be neglected. In For the opening of via-holes it is therefore important that (a) the contact line of the initial droplet is pinned, (b) that the contact angle of the droplets on top of the polymer to be dissolved is sufficiently small, and (c) that evaporation of the the case of IPA on PVP the contact angle is on the order of 12°, and the droplets ypically dry within less than 1s. The smaller the contact angle, the faster will be the capillary flow velocity inside the droplet, i.e. the more reliable will be the formation of the side wall. However, on the other hand, the smaller the contact angle the larger the droplet diameter. An optimum contact angle therefore exists to achieve small diameter via-holes with well-defined side walls. To achieve a larger contact angle for a good solvent PCT/GB00/04934 WO 01/47643

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the surface of the substrate may be freated, for example with a self-essembled mondager with a larger repolleror for the solvent. The self-sussembled mondager may be patterned, such as to provide thydrophobic and hydrophobic surface egions, in order to confirm the deposition of the solvent to a small sexual engines, in order to confirm the deposition of the solvent to a small sexual s

The ducht and dath rate of the via hold can be combined by a conclusion of the number of drops of solvent that are optiopal, it is frequency at which they are disposated, and the then of expenden of the solvent in comparison the harbe at which it is capable of dissolving the substate. The environment is which the appeals of dissolving the substate. The environment is which the appeal of the solvent in the substate is the solvent in the solvent of dissolving to only slowly extend to the solvent may be used to finit the augmin of dissolving.

Since the layer sequence of the TFT consists of alternating poter and non-poter asyems, it is possible to choose solvents and solvent combinations such that stothing stops at well defined depths.

I note to make outside though the whole an exclude layer may be deposited over it so that it exclude the major that the control to the source of the source

Figure 13 shows at curre 30 the current voltage characteristics measured between the bottom PEDOT electrod 25 and a conciding sector or 20 deposited on top of the PMP gate instanting layer 32. The diameter of the vie has west 50, mr. For comparison, curve 31 shows a reference sample, in which no view was 50, mr. For comparison, curve 31 shows a reference sample, in which no view was 50, mr. For comparison, curve 31 shows a few part of bottom electrods. The consequentiation clearly when the for current through the view-bate is sowered rotter of magnitude higher than the lessage current through the gate invision to

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be absence of the wide has the measured current requestive these is trivially be absenced or the wide the measured current regular three performances of the performances are can be seen to perform constantively measurement of the windows PECOT is extracted. It is not immediately the measurement of the windows the hard or will necessary the measurements in the windows have a measurements in the contract of the windows from these measurements in the contract of the windows from these measurements in the windows the performance of the windows from these measurements in the coordinate of the performance of the perform

The method of the false formation contented above in reliation to legister 12 is directly applicable to depiction-type devices devices without a diffusion barrier (air injure) ((i)) and to devices in which the diffusion barrier is deposited after the operating of the vehicles (tagent (4)) and the content of the type of the content of

If an even broad contact enableshing is equalled that the astronductor, payer may also be removed at the 4th bode site. This is preferrebly done after the diffractor bentier has been formed. The diffusion bentier 7 and the semiconducting polymer 4 can be boundly advended by Use apposition of a good-bowerf for home -such as yelver in this example, preferred production for the semiconducting and the messaling manifest, both beyon may be dissolved at the same time. A divice in which the sub bean done followed by deposition of the gate electrical is shown in flaure 4(4).

Mixtures of solvents can also be used to reduce the diameter of the via-hole by Increasing the contact angle of the solvent mixture on the layer to be dissolved.

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An otherwise beneficies be berring or who the interconduction and the opposition on concactor mentation to find it is to comply detected mentation to find it is to comply detected an administration of the concision. On consolidation of the control of the contro

The method of whiche formation strongs PPP detaching layer can be used to connect the gas electrode of the TFT to a source or daris electrode in the underlying layer can be sufficiently for a surror or daris electrode in the underlying layer as required in charge planning circuit. Figure 18 shows pick of the characteristics of enhancement lead in few der devices formed with two normally-off transistor devices as in figure 15(b). Two hereitra with two normally-off transistor devices as in figure 15(b). Two hereitra with two normally-off transistor devices as in figure 15(b). Two hereitra with off off the darise with the cannot prove the configuration of the darise whole to cannot find the first off the darise and the provided violage changes in the 5(b) (201) to a rippi low (407) states when the horizon darisping endanges in the 5(b) (201) to a rippi low (407) states when the horizon darisping endanges the first of the contradedicties in larger than it, which is a reconstruction to allow the standardors of more complex dends such as reconstruction.

Vehicles as decisional boxon para plan based by proble described corrections. Whether as decisional problems are required. Fro compare selectoric draws multieved infractorised stemmes are required. This may be labiticated by disposing a sequence of insecribed 17 and efficient diseases beyon 10,17 disposing from compatible activities (Igare 16(6)). Vehicles 17 as an than the deposited from compatible activities (Igare 16(6)). Vehicles 17 as an than the

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formed in the way described above with the interconnect lines providing automatic etch stop.

Examples for explore described measurements as post-pointers (10) such as PVP and norspool elektrick polymers (10) such as polymers (10) such instead or deposited alternatively from point and non-point and non-point and non-point and non-point and post-point and deposition of lost about his first provincial and execute his respective layer and provincial and excepting delectric layer provincial and excepting polymers.

in exiculty materials and deposition processes for devices of the type described bebow, it control that gets absortages can be obtained feet in the deposited from a solvent that does not substantially disease in immediately carefulful from a solvent that does not substantially disease. In this way, successive layers and the built up by adding processing. One way to simply selection of each materials and process adopts to a thin to deposit we of more layer advantable, from pour end non-point manages, as exemptified for the layer sequence described above. In the way mailingue devices containing positio, concluding semiconducting and insulating layers can readily be formed. This can obstunded the problems of describing services with and and analysing layers.

The device structures, materials and processes described above ere merely illustrative, it will be appreciated that they may be varied.

Other device configurations than the top-que configuration abown in figure 1 may be used. An allearative configuration is the most extracted collectings configuration shown in figure 17, in widn it is also possible to incorporate a distance barrier? and surface modification layer 8 if required. In figure 17 like partie are numbered as for figure 1. Other device configurations with different layer sequences may also be used. Devices other than iteratives may be formed in an analogous way.

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PEDOTFPSS may be replaced by eny concluding poymer that can be deposited from anulant. Examples include poyer-like or polyprime. However, some of the anitacide includes completely one of PEDOTFPS are: (a) a polymeric cigoant (PSS) with interestry in orditure-like, (b) pood harmal satisfy and stability in sit, and (b) at work traction of a 5.1 eV hat is well matched to the fortunation potential or common hole-trapping amenizorabiding polymers allowing for efficient hole of large center (highed). Effective days granter insplication technical in production abord-cannel immediate devices with channel length L. < (gran, in such produces accordant contact metables effects with channel length L. < (gran, in such produces during which is produced to the contact of the conta

The conductivity of PEDOT/FRSS exposales from a vetter solution (Baykran P) is on the order of 0.1-1 Start. Higher conductivities up to 100 Start can be obtained with formulation that contain a mixture of selevants (Baykra CPP 1-151), constaining expropancia and Nemerly-R-pyrindiction (MANP). In this lastre case care needs to a suite an that the owner containing on the formulation of the formulation is compatible with the obtaining requirements of the layer sequence. For applications in which seem higher conductivities are mapping offer conductivities are mapping offered as work as collected suspensedors of matalian inclusions for a solution to the conductivities are an inquired offer conductivity polymers or an addition-processible involution conductors, such as collected suspensedors of metalian inquires for the resulting includes in a facility time to be used.

The processes and devices described herein ere not limited to devices fabricated with solution-processed polymers. Some of the conducting electrodes of the TFT

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and/or be interconnect in a critical or display device (see below) may be formed from hospitatio concludes, that can, for example, begoing by printing of a colidoal suspension or by electrophisms on a pre-polarimate subsetitus. In devices in which lost all signs are to be dispetited from polation one or more PEDOTYPSS purkness of the device has been prepared with an insoluble conclusive malerial such as a vecaum-populae conductor. The seriococculoring paier may also be repeated by sucher subdiscripcoussible seriococculoring relating to be repeated by such such subdiscripcoussible seriococculoring relating to the subdiscripcoussible seriococculoring operatoring relating to the relating section of the subdiscripcous found maniesta sectionalization to such companies to sectionalization to the subdiscripcous found maniesta sectionalization to subdiscripcous subdiscripcous subdiscripcous subdiscripcous found maniesta sectionalization continuous subdiscripcous found maniesta sectionalization subdiscripcous found maniesta section subdiscripcous found maniesta subdiscripcous su

The electronic may be patiented by behardques for them inkigel printing. Suitable startingnes hadron and illustration printing (LA Rogart et al., App.) Phys. Lett. 75, 1010 (1990); S. Birthain et al., Physical World May 1996, p. 31). Secure patient (E Basel et al., Chinghai World May 1996, p. 31). patienting (Dea W. O SERGOSIO or patients, or implied dependence authority and patients with hydropholic authority, and implied for tages on patienting with hydropholic authority in contributed to be patienting with patients for tages was patienting with population for tages was patienting with pool organization for tages was patienting with pool organization. The patienting value and patients by the policy organization for tages was patienting with pool organization.

Instead of a glass shout, the device(s) could be deposited on to sucher substrate materials, such as Perspax or a flexible, pessell substrate such as polyeteraulphone. Such a material is preferably in the form of a sheut, is problemed of a polyeteraulphone and many be transparent endor flexible.

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Although preferably all layers and components of the device and clocul are deposed and components of the device and clocular the deposed of the components balenned by aciditing non-processing and partial predictions one or amount of the components are a sentimentally always may proceed by when the components of the c

Devices such as The fabricated as described above unity by part of a more prompted circuit of device in which one or most excit devices an extra properties of the properties of the such owner and owner devices. Exemples of explications having about original and about mark circuits and about mark circuity for a display or a memory device, or a user-defining the surry discut.

atmosphere the conductivity increased to 2 S/cm. By diluting the solution with 3S the conductivity could be decreased by orders of megnitude. For a The besic component of a logic circuit is the inverter shown in figure 15. If all ransistors on the substrate are either of the depiction or of the accumulation type three possible configurations are possible. The depletion-load inverter (figure 15(a)) is sultable for device that ere normelly on, (figure 1(c) end 3), and the anhencement-load configuration (figure 15(b)) is used for normally-off transistors (figures 1(a/b) and 4). Both configurations require a via-hole between the gate electrode of the load transistor and its source and drain electrode, respectively. An atternative configuration is the resistance load inverter (figure 15(c)). The atter device can be fabricated by printing a thin, narrow PEDOT line of adequate length and conductivity as the load resistor. By reducing the conductivity of PEDOT, for example by increasing the ratio of PSS to PEDOT, the length of the resistor line can be minimized. The conductivity of Baytron P PEDOT/PSS with a PEDOT/(PEDOT+PSS) weight ratio of 0.4 was measured to be on the order of 0.2 S/cm for an as-deposited film. By annealing to 280°C for 20 min under No. PEDOT/(PEDOT+PSS) weight ratio of 0.04 a conductivity of 103 S/cm was neasured after annealing at 280°C. Resistors with a resistance of 50 MΩ were

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labricated by trivial printing a line of PEDOT with a width on the order of 60µm and a length of 500µm.

The different right printing components but have been developed, i.e. transitions, whose intercorrelations, residens, coprollers, multilayer but pre-controllers are not being and an electronic closule. By a completion of deep being and solden processing, higher forming can be used for all processing parties, from the used for sail processing spring when based parties the multilayer is exquired. The transition have closule described above as the budding placed for mine complete, printing can be used for all described above as the budding placed for mine complete logic chairs.

Solution-processed TFTs as electrical brown may be used as pola whiching transistor of acide match displays along a figure of acide match displays (a). Contissory et al., Nature 364, 235 (1969), for which a standard cappar (6), contissory et al., Nature 364, 235 (1969), for which a standard standard at et al., Samraplaus, at et, Schenz 200, 1741 (1989), for which a standard caple standard processing expense of a standard cappar (1989), for which a standard capital season in figure 18(s)) or as an action match expenses of expenses of the standard of a randorry devide, and as extraord match and the standard process of the standard of a randorry devide, and the standard process of the standard process of the standard of the standard standard at the standard of the standard and the standard standard and the standard standar

Examples of possible others configuration is construct we voltage on the electrod of a LOG or an electrodycate dispays are about in figure 19. In which line pure are nationed as for figure in. In the drawings of figure 19. (as for figures 17. In, and 17, the example) but gath interface; play may play also a multilage structure containing a cities on before andre surface modification layer, as in figure 1(s). Referring to figure 16, the source and gate electrodes 2, 3 of the TFT are connected to the date of and extended 35 these of the active mater, with may be medicated the and a different consulting materials to active adequate concluding view forger from the materials. The date electrode 3 of the FFT may also be the

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again eachers, it is pass election they be termed to either conducting making in figure in figure 1: the processivation was proplication of an electric interference and the processivation of an electric interference and electric control dispays electric of some a logic office or electrocheristic interference in the first interference in the eighthing the first interference in the eighthing on the data and additional additional and additional additional and additional additional and additional additional additional and additional additiona

The configuration in figure 16(9) is more contributed chowever, the whole photol or a large perior of the point are a setable for the TFT and interconnel fines, and it as disting earlier for the segrets on the date and addressing lines 44, and 42 by the plotal electrode 41. Fabrication of this configuration requires an additional deletation layer 42 and a "whole filled with conduction majories and additional deletation layer 42 and a "whole filled with configuration requires an additional deletation layer 42 and a "whole filled with configuration requires and the point electrode 41 to the TFT cain electricide 3. The wholese and he full interceded the point by the procedure deserbed above.

Who sets at in moderly carding the greater and cast the membrated and rary be appropriated 10%. The configuration can also be used for distript appropriated 10%. The configuration can also be used for distript appropriated with a tacklight subsequent for the set of the set o

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direction (got hashed -[1]) is more strongy absorbed than fight positional propredication to the alignment direction (but liaiseliad-1.). The optical antibutions on be used in a LEO delaye to further increase the optical transportment of the positional business the optical transportment of the positional between the globes because the object of the control of the positional between the globes because and the bestigious founder between the globes and the bestigious of the bestigious devices appear adminst objective ends in which the globes and the bestigious of the FRT age, is believed to the control of the position of the position of the second transport of the videos appear and the best layers of the FRT age is believed to the position of the videos appear and the position in the videos appear and the

Another advantage of the low option theoryton of the semi-conocity layer is the motions photobreaeability of the all communities to violate light. In the case of amorphous allow. The is black maint's has to be used to prevent import for current under light lumination. In the case of polymer TFTs with wide being gas emitococholosis is not required to protect the TFTs from ambient light and from the beautight of the display.

The configuration in figure 19(9) is also well suited for the other trensistor 11 of an End Delspoy (ignor 19(9)), since 1 shows the other current of the 17% to be increased by inchestion of an interdigitated array of source-drain sectors with imps chemical width W making use of the full area undermach the point electrode. Attentatively, the bottom-gate TFT configuration of figure 17 can also be used in all of the above applications (figure 19(c)).

One of the hundred technologial leases for the infliciency of entire mixing control the undergonal sease of the infliciency of entire mixing entrol the throughout the Proof PUS ST FT and publicates a Na of the male in throughout between the PLOTOP ST FT and publications as not be the male in through the public through through the public through the public through the public through through through the public through the public through the public through the public through the public through through through through through through through

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possible solution is the fabrication of intercorned lines end pixel electrodes 43, the act of from inclum-lin-cade (ITO) or fundium, tungsten and other refractory man act another medical baring more stability in this environment, or the use of suitable burine rigor.

In the case of a display application it may also be destrable to flabricate TFTs with a small channel length by printing onto a pre-patterned substrate indicated as 10 in figure 19, as described above.

Sinital device configurations for either matrix transistor evaluties can also be element sich pixel element to be controlled is not a display element but a memory element sich as e capacitor or a diode, as for example in a dynemic random access memory.

noles and conducting lines.

no addition to the conducting adestrockes, some of the other layers of the TFTs may use be patiented by detect printed methods, as und he accesses partially or LIP. These 21(4) (in which the parts are numbered as for figure 1) shows a sonce in which an active service instead the transcriptional control and the first 1) shows a sonce in which an active and the page of the partial control and the control control and the control and the control control and the count profit the control and the

A plantilly of closures former at execution above the former on a slight statement and referencement by controller's length. The devices may be formed on a slight length of or on more than one lenvit, some devices being formed on top of commer, by the offices, being formed on top of commer, by use of infractioner depth and vehicles we described above explanding compact closural small be formed.

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The bachrology developed here for the factication of the-jet printed transistors, de-brides and infercorned here may be used to facticate integrate deservoir electronic deservoir deservo

It is also possible that the prefabricated substate may already contain one or more of the connected of the instance of electronistic of electric business or contain, for example, an error of completed roopsile tensitied devices each institute one exposed electrods. In this case int-jet fabrication of en insegrated circuit would comprete the formation of electrical connections between pairs of the properties and the deposition of eachiest connections between pairs of the properties and the deposition of a english of multilevel intercornect achieves the properties undeposition for a english of multilevel intercornect achieve state intercornect achieves the properties of the properties of

In addition to transistor devices the electronic circuit may also compute other ache and passive circuit elements such as display or memory elements or capacitive or resistive elements.

Using the auchinques coarcitived above a ust lawing a putality of translation may be formed and are cardioused above a ust lawing a putality of translation may be a specific subsequent use by means of solution-based processing. For example, a substate lawing or plantly of translations 50 of the type above in figure (iq., [o) or (i), in the form of operating cardious among to on plantle sealor (iq. par. 22). Other of solving such as diotes or capacitions may also be formed or the sheet. Then the sheets

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who be packed in sink-gardiner through gallings and for a subther solvent for controlled whoses SC (e.g. method) and a shallone marked for forming controlled trades SI and for filling viel-base (e.g. PEDOT). The bis-led printer may be operate under the control of a subtile programmed compani, revisig involvedage of the location and configuration of the transistors can the select. Then, by a combination of viel-base formation of the transistors can the bis-led printer and configurate to citized for preforming a dealed electronic or logic landler, by intercontenting the transistors in the desired way. This exchosopy that selects the formation of kiglo-specific crucils on substrates using small, innepensive systemats. attemples of the agriculture date in central set for printing of exten exidence clocks, lappage and identification lags. A feet of tag printing device may be used with a number of mexcelligated units auch computing of excellent booked with a number of mexcelligated units auch computing a seaton mortifier a purely of the feet of the computer of the seaton of the se

User-defined circuits other than for pricing or tagging purposes may be fabricated in a similar way. Verification end reading of the circuits may also be mede by

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remote probing using for example redio frequency radiation (Physics World March

1999, page 31).

The ability of the end-user to define circuits by simple ink-jet printing of appropriate connections onto a standard array offers significantly increased fleatibility compared to factory-designed circuits.

The present invention is not imited to the foregoing examples. Aspects of the present invention include all rowel and/or inventive aspects of the compise described herein and all rowel and/or inventive combinations of the features described herein.

The applicant countries are the first it by present inventions may incube any feature or combination of leatures discolored breath either insplictly explicitly or any generalization haved, without fination to be scope of any definitions and each chose in view of the foregoing description is like the orderst be person skilled in the art that various modifications may be mede within the scope of the revenitions. PCT/GB00/84934 WO 01/47043

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### CLAIMS

# A method for forming a transistor, comprising:

depositing a first material from solution in a first solvent to form a first layer of the transistor; and subsequently

whist the first material remains soluble in the first solvent, forming a second layer of the translator by depositing over the first material a second material from solution in a second solvent in which the first meterial seutstandialy insoluble.

A method as claimed in claim 1, comprising the further step of, whilst the second materies remains soluble in the second solvent, forming a third layer of the translate by depositing over the second material a first metalen from solidion to third solvent in which the second material is that abstentially instolute in

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A method as claimed in claim 1 or 2, wherein one of the fitst and second solvents is a polar solvent end the other of the first end second solvents is a non-poler solvent.

e

4. A method as in dalins 1 to 3, wherein one of the first or second materials is a semiconductive material, and the other of the first or second materials

is e delectric material.

- A method as in claim 2, wherein the second material is a deleachic material, one of the first or third materiels is a semiconductive material and the obbit of the first or third materials is a conductive material.
- A mathod as delimed in eary of claims 1 to 5, whereful one of the first and second dayses is a monpholer polymer layer that is solidable in a monprofer solved and be other of the first end second layers is a point polymer layer that is solidate in a polar solvent.

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- A method as claimed in claim 6, wherein the interaction parameter D for the non-polar polymer and the polar solvent is larger than 5.
- A method as claimed in claim 6, wherein the interaction parameter D for the non-polar polymer and the polar solvent is larger than 10.
- A method as daimed in claim 6, wherein the interaction parameter D for the non-polar polymer and the polar solvent is larger than 15.
- 10. A method as claimed in claim 6, wherein the interaction parameter D for the poler polymer and the non-polar solvent is larger than 5.
- A method as cleimed in daim 6, wherein the interaction parameter D for the poler polymer and the non-polar solvent is larger than 10.
- 12. A method as cleimed in datim 6, wherein the interaction parameter D for the polar polymer and the non-polar solvent is larger than 16.
- 13. A method as dairned in cleim 3 as dependent on delin 2, wherein one of the second and third solvents is e polar solvent and the other of the second and third solvents is a non-poler solvent.
- 14. A method as claimed in claim 2, wherein the second solvent is a moderably poles solvent containing a pole and a mo-pole group and one of the first and third solvents is a highly polar solvent containing only polar or out.
- 13. A mathod as claimed in claim 14, wherein the second polymer layer is a moderately poler polymer layer soluble in a moderately poler solventi, and one of the situ or third polymer layer is a non-poler power layer, and the other of the first or third polymer layers is poler polymer layer.
- 16. A method as datined in claim 14 wherein the interaction parameter D for the mon-polar polymer end the moderately polar solvent is larger then 5.

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A method as claimed in claim 14 wherein the interaction parameter D for the non-polar polymer and the moderately polar solvent is larger than 10.

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- A method as daimed in daim 14 wherein the interaction parameter D for the non-polar polymer and the moderately polar solvent is larger than 15. 18
- A method as daimed in claim 14 wherein the interaction parameter D for the polar polymer and the moderately polar solvent is larger than 5. 9
- A method as dalmed in claim 14 wherein the interaction parameter D for the polar polymer end the moderately polar solvent is larger than 10. g S
- A method as daimed in daim 14 wherein the interaction parameter D for the polar polymer end the moderately polar solvent is larger than 15. 2
- A method as delimed in any of claims 14 to 21, wherein the moderately polar solvent is an alcohol. ä
- A method as delmed in any of claims 14 to 21, wherein the moderately polar solvent is an acatate. g
- A method as claimed in claim 2, wherein the first layer is soluble in a nonpolar solvent and the second layer is en isolation layer soluble in a noderately polar solvent containing e hydrophilic and a hydrophobic group. ž
- A method as claimed in claim 24, wherein the third layer is soluble in a polar solvent. 22
- A method as claimed in claim 24, wherein the third layer is soluble in a non-poler solvent ģ
- A method as deimed in any of dalms 24 to 28, wherein the second layer is an active layer of the transistor. 27.

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- second layers is a source and/or drain electrode layer of the transistor and he other of the first and second layers is a semiconductor layer of the A method as claimed in any preceding claim, wherein one of the first and 28
- A method as daimed in any of claims 1 to 27, wherein one of the first and second layers is a semiconductor leyer of the transistor and the other of the first and second layers is an insulator layer of the transistor. 8
- A method as claimed in claim 28 or 29, wharein the semiconductor layer comprises a conjugated polymer.

Ö.

- A method as claimed in cleim 28 or 29, wherein the semiconductor layer comprises a conjugated block copolymer. 뛵
- comprises a block copolymer comprising a first block of conjugeted nonomer units each linked by at least two covalent bonds, and a second A method as claimed in claim 28 or 29, wherein the semiconductor layer slock of monomer units, the block copolymer having an electron affinity greater than 3.0eV or 3.5eV. 32
- A mathod as daimed in claim 28 or 29, wherein the semiconductor layer comprises a block copolymer comprising a first block of conjugated monomer units each linked by at least two covalent bonds, and e second block of monomer units, the block copolymer having an ionisation potential in the range from 5.5eV to 4.9eV. ä
- A method as claimed in claim 15 or 33, wherein the first block of monomer a phenylene derivative and en indenofluorene derivative and the second block of monomer units comprises one or more of the group comprising a units comprises one or more of the group comprising e fluorene derivative, ğ

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- thiophene derivative, a triarysamine derivative and a benzothiadiazole
- A method as dalmed in claim 28 or 29, wherein the semiconductor tayer polymer is F8T2 or TFB. 38

comprises a liquid-crystalline conjugated polymer.

A method as claimed in claim 28 or 29, wherein the semiconducting

35.

- A method as claimed in claim 36, comprising the step of heating the liquidcrystalline polymer into its liquid crystalline phase. 37
- A method as delimed in claim 36 or 37, comprising the step of aligning the iquid-crystalline polymer uniaxially. 38
- A method as daimed in daim 38, wherein the step of aligning the liquidcrystal polymer comprises depositing the liquid-crystalline polymer on to a ayer having an aligned molecular structure 38
- A method as claimed in claim 39, comprising the step of aligning the molecular structure of the said tayer by mechanically rubbing the layer. <del>4</del>
- A method as claimed in claim 39, comprising the step of eligning the molecular structure of the said layer by optically treating the layer. 4
- A method as cigimed in any of claims 28 to 24, wherein the semiconductor layer is optically transparent with a band gap larger than 2.3eV, preferably arger than 2.5eV 45
- A method as clamed in any of claims 28 to 42, wherein the semiconductor layer has an ionisation potential larger than 4.9eV. 43
- A method as clamed in any of claims 28 to 42, wherein the semiconductor leyer has an ionisetion potential larger than 5.1eV. 4

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- A method as clamed in any of claims 28 to 42, wherein the semiconductor ayer has an electron affinity larger than 3.0eV. 4
- A method as clamed in any of claims 28 to 42, wherein the semiconductor layer has an electron affinity larger than 3.5eV. 46
- A method as dalmed in any of claims 1 to 13, wherein one of the first and second layers is an insulator layer of the transistor and the other of the first and second layers is a gate electrode layer of the transistor. 47.
- A method as claimed in any of claims 2 to 13, wherein one of the first and third layers is an insulator layer of the transistor, the other of the first and third layers is a gate electrode layer of the transistor, and the second layer is an isolation layer of the transistor. 89
- A method as claimed in claim 48, wherein the Isolation layer is a diffusion barrier layer. 6
- A method as claimed in claim 49, wherein the diffusion barrier layer comprises a non-polar polymer. S,
- A method as claimed in claim 49, wherein the diffusion barrier layer comprises a non-polar conjugated polymer. 5
- A method as delimed in claim 49, wherein the diffusion barrier layer comprises a polyfluorene derivative. 23
- A method as claimed in claim 52, wherein the polyfluorene derivative is -8, F8T2 or TFB. ŝ
- A method as claimed in any of claims 48 to 53, wherein the Isolation layer is a surface modification layer. Ą.

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A method as claimed in any preceding claim, comprising the stap of modifying the surface of the first layer prior to depositing the second layer.

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- A mathod as delimed in claim 55, wherein the surface modification of the first layer is such as to provide a contact angle of less than 100" for deposition of the second material onto the first layer.
- 57. A method as claimed in delim 55, wherein the surface modification of the first layer is such as to provide a contact angle of lass than 80 for deposition of the ascond material onto the first layer.
- 58. A mathod as claimed in daim 55, wheven the surface modification of the first layer is such as to provide a contact angle of less than 80' for deposition of the aecond material onto the first layer.
- 59. A method as daimed in any of claims 55 to 58, wherein the step of modifying the surface of the first layer comprises treating the surface of the first layer.
- 60. A method as claimed in any of claims 55 to 56, wherein the step of modifying the surface of the first layer comprises depositing a surface modifying material on to the surface of the first layer.
- A mathod as claimed in claim 80, wherein the surface modifying material is deposited from solution in a moderately potar solvent.
- 62. A method as deimed in any praceding daim, wherain the first layer is deposited on to a substrate, and the method comprises heating the substrate prior to deposition of the second or third layer.
- A method as daimed in any preceding claim, wherein at least one of the first, second and third layers is formed by ink-jet printing.

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- 64. A method as claimed in claim 63, wherein at least one of the source, drain or gate electrode of the transistor is formed by ink-jet printing.
- 65. A method as dalmed in any preceding ciaim, wherein the transistor has a source, drain or gate electrode formed of a conducting polymer.
- A method as delined in claim 65, wherein the said electrode is formed of an optically transparent conducting polymer.

- 67. A method as daimed in daim 65 or 66, wherein the conducting polymer contains a polymeric counterion dopant.
- A method as claimed in any proceding daim, wherein the material of one
  of the first and ascond layers is PEDOT/PSS.
   A method as claimed in any prescioling claim, wherein the translator has an
  89.
  - A method as claimed in any preceding claim, wherein the transistor has a insulator layer formed of a non-conjugated or partially conjugated polymer.
- A method es claimed in claim 69, wherein the insulating polymar contains both hydrophilic end hydrophobic groups and is soluble in a moderataly polar solvent.
- 71. A method as claimed in any preceding claim, wherein the material of one of the first and second layers is PVP.
- A translstor comprising:
- a first active layer that is soluble in a first solvent, and a second a second active layer adjacent the first layer and soluble in a second solvent in which the first material is substantially insoluble.
- A transistor as dalmed in daim 72, comprising a third active layer adjacent.
   the second active layer and soluble in a third solvent in which the second material is substantially insoluble.

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- 74. A trunsistor as claimed in claim 72 or 73, wherein one of the first and second layers completes a polar polymer that is solicible in a polar polymer, and the other of the first and second layers is a non-polar polymer soluble in a pon-polar polymer soluble in a pon-polar polymer soluble.
- 75. A transistor as claimed in claim 74 as dependant on calinn 73, wherein one of the account and third layers comprises a polar polymer soluble in a polar solvent and the other of the second and third layers is a con-polar polymer soluble in a non-polar solvent.
- 76. A transistor as claimed in claim 74 as dependent on claim 73, wherein one of the solvents is an alcohol.
- 77. A translator or plained in any of dailins 72 to 15, wherein one of the first and second layes is a source and/or dain electrode layer of the translator and need the other of the first and escond layers as a semiconductor layer of the translator.
- 78. A transistor as delimed in eny of dalims 72 to 76, wherein one of the first and second layers is a semiconductor isyer of the transistor end the other of the first and second layers is an insulator layer of the transistor.
- 79. A transistor as delimed in claim 77 or 78, wherein the meterial of which the semiconductor layer is formed is a polyfluorene derivative.
- A method as claimed in any of claims 77 to 79, wherein the semiconductor layer is optically transparent with e band gap larger than 2.3eV, preferably lenger than 2.5eV.
- A method as claimed in any of cleims 77 to 79, wherein the semiconductor layer has an ionisation potential larger then 4.9eV.

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- A method as clamed in any of claims 77 to 79, wherein the semiconductor layer has an ionisation potential larger than 5.1eV.
- 63. A method as adament in equicary To 127, wherein the semiconductor and present comprises a black copolymer correlating a first back or conjugate mornomer units and hierar by at least two consent brank, and a second black of mannomer units, he back copolymer having an electron affinity greater than Alon's 45-50.
- 64. A method as delensed in any of ciamins 77 to 79, wherein the semiconductor layer comprises a block copolymer comprising a first block of configuration monorime utils each lines by at least two covelent bonds, and a second block of monorime utils, the block copolymer having an ioniseation pointed in the sneeper tron Sickly to AgeV.
- 65. A method se delmed it claim 66 or 67, wherein he first block of inconcret units consistent on or not by oppurationally a flucture defendes, a phenylene derivative end on indenditionate derivative and the second block of inconfrer that completes one or more or the propo comprising a thickness derivative, a triarylamine derivative and a berazchialdiazole Annealment.
- A method es dalmed in claim 79, wherein the polyfluorene derivative is F8T2 or TFB.
- A transistor as clamed in any of cleims 77 to 86, wherein the semiconductor layer has an ionisation potential larger than 4.3eV.
- A transistor as ciarned in any of claims 77 to 86, wherein the semiconductor layer has an ionisation potential larger than 5.1eV.

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A transistor as dalmed in any of claims 72 to 76, wherein one of the lifest and second layers is an insulator lever of the transistor and the other of the first and second layers is a gae electroda layer of the transistor.

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- 90. A transistor as claimed in any of claims 73 to 78, wherein one of the first and third loyers is an insulator injent of the transistor, the other of the first and third layers is a gate electrocial leger of the transistor, and the second layer is an isolation layer of the transistor.
- 91. A transistor as dalmed in claim 90, wherein the isolation layer is a diffusion barriar layer.
- 92. A translator as claimed in claim 91, wherein the diffusion barrier layer comprises a polyfluorene darivative.
- A transistor as claimed in claim 92, wherein the polyfluorene derivative is F8T2 or TFB.
- 94. A transistor as delimed in any of daims 90 to 93, wherein the isolation layer is a surface modification layer.
- A transistor as claimed in any of claims 72 to 94, wherein the first or second layer is formed by Ink-jet printing.
- 96. A transistor as datmed in any of datms 73 to 94, wherein the third layer is formed by ink-jet printing.
- 97. A transistor as dalimed in any of dalima 73 to 95, wherein one of the first, second and third layers is a source layer of the transistor, another of the first, second and third layers is a darta layer of the transistor, and the other of the first, second and third layers is a gate layer of the transistor.
- A transistor as claimed in of claims 72 to 95, wherein the material of one of the first and second layers is PEDOT/PSS.

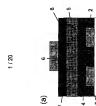
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- 99. A transistor as claimed in any of claims 72 to 96, wherein the material of one of the first and second layers is PVP
- 100. A translstor as claimed in any of claims 72 to 99, wherein the transistor is optically transparent.
- 101. A transistor as claimed in any of claims 72 to 100, wherein the transistor is a thin film transistor.
- 102. A logic circuit, display or memory device comprising a transistor as claimed in any of dains 72 to 101.
- 103. A logic circuit, display or memory device comprising an active matrix erray of a plurality of transistors as dalimed in any of cialms 72 to 101.
- 104. A display comprising a plurality of display elements, at least one of the display elements being ewitched by an optically transparent thin film transistor.
- 105. A display as claimed in claim 104, wherein the said transistor is located bethind the display element.
- 108. A Gásgue a definantel ridar in Cis, heneos he pulgary demancio comprises an opelarisy actives ropico sericabatio by the translator and the brandistric is electrically coupled to the optically active region by means of conductive meanist located in a via tube formed through as least one layor of the translator.

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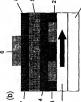
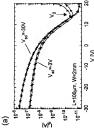






FIG. 1







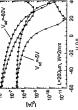
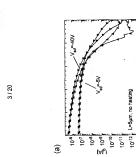


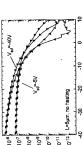
FIG. 2

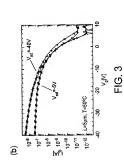
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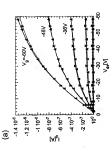


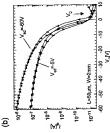
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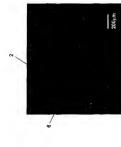






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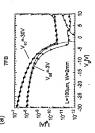






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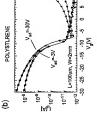


FIG. 6

FIG. 5

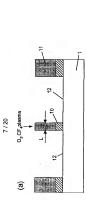


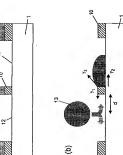
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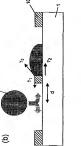
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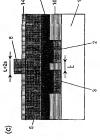


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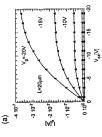
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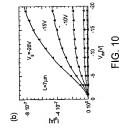
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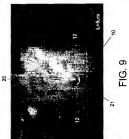
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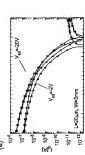
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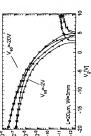
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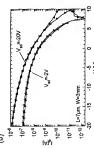
Outer diameter

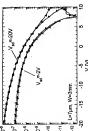
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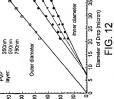
Inner diameter

PVP layer





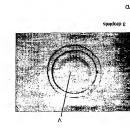


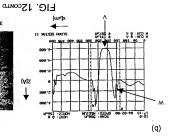


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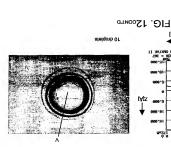
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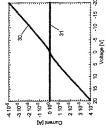
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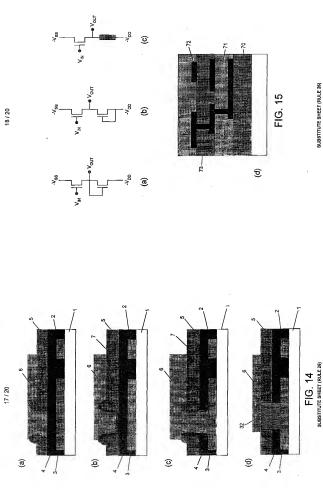


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FIG. 13

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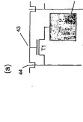
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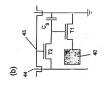
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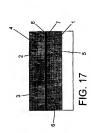
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1,68,72, Mensel to claim No. 72 onal Application No PCT/GB 00/04934

GRETOWER ET AL. "GRACEPERAZION OF THE PRODICES STREEN BY MEANS OF "A-BAY AND ULTANIONED PRODICECTORN SPECTROSOPY" THIN SOLID FLUE, ELEVITA-SEGULIA S.A. ADMANIE, IN. 1/47 Z. October 1999 (1999-10-02), pages 122-153, RODOS DIBRIC 2 I EL RI. "LON-COST ALL-POLYMER NYELEMENTED ICTEDITIES ARE NOW. APPLIED PRINCIS LEFFIES, MARKETON INSTITUTE OF PHYSICS, NEW YORK, ON 1, 75, no. 1, 6 July 1998 (1998-07-06), page 108-110, XYORD71181 STSH: QUAD-9551 The While GOLDMAN. REDECKER M ET AL: "MOBILITY ENHANCEMENT THROWEL HOMOGENED SHRATIC OF A LIQUID-CRYSTALLINE POLYFLUGRENE" PAPLIED PHYSICS LETTERS, US, AMERICAN TAYSTIUTE OF PHYSICS. NEW YORK, REDCEEN KET AL: "NONISPERIUF FOLE NAMEDORIT IN AMELICAN POTEUDRING PRISCE LETTER, US, MERICAN INSTITUTE OF PRISCE, RET 1004, 70 of 17 at 10 of 1 vol. 74, no. 10, 8 March 1999 (1999-03-08), pages 1400-1402, XP000805915 ISSN: 0003-6951 the whole document the whole document the whole document

page 1 of 2

Köntgstein, C 14/03/2001 Authorized office

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Name and making address of the ISA. 8 March 2001

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